# $\frac{\text{MOSFET}}{\text{SUPERFET}} - \text{Power, N-Channel,} \\ \text{SUPERFET}^{\texttt{R}} \text{ III, Easy Drive,} \\ \text{650 V, 17 A, 190 m} \Omega$

#### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

#### Features

- 700 V @ T<sub>J</sub> = 150°C
- Typ.  $R_{DS(on)} = 159 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 33 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 300 pF)
- 100% Avalanche Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

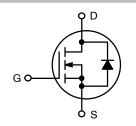
- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



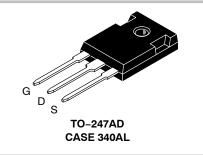
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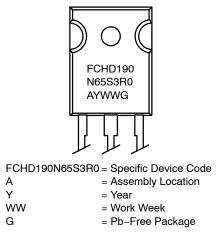
V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
650 V	190 m $\Omega$ @ 10 V	17 A	



POWER MOSFET



#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit V	
V <sub>DSS</sub>	Drain to Source Voltage			650
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	17	А
		Continuous (T <sub>C</sub> = 100°C)	11	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	42.5	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		76	mJ
I <sub>AS</sub>	Avalanche Current (Note 1)		2.5	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		1.44	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	144	W
		Derate Above 25°C	1.15	W/°C
TJ, T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 2.5 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 8.5 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.87	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCHD190N65S3R0-F155	FCHD190N65S3R0	TO-247AD	Tube	N/A	N/A	30 Units

# ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	<u>.</u>				
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C		0.6		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS}$ = 520 V, $T_{C}$ = 125 °C		0.89		1
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30$ V, $V_{DS} = 0$ V			±100	nA
ON CHARACTE	ERISTICS		-	-		
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.39 \text{ mA}$	2.5		4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		159	190	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		10		S
YNAMIC CHA	RACTERISTICS	·			•	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1350		pF
Coss	Output Capacitance			30		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		300		pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		43		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 8.5 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		33		nC
Q <sub>gs</sub>	Gate to Source Gate Charge			7.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			14		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.5		Ω
WITCHING CH	HARACTERISTICS	·			•	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega \\ \text{(Note 4)}$		17		ns
t <sub>r</sub>	Turn-On Rise Time			16		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			42		ns
t <sub>f</sub>	Turn-Off Fall Time			6		ns
OURCE-DRAI	N DIODE CHARACTERISTICS	-	-	-	-	-
۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current				17	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current				42.5	Α
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 8.5 A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>DD</sub> = 400 V, I <sub>SD</sub> = 8.5 A,		313		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/μs		4.9	l	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

### **TYPICAL PERFORMANCE CHARACTERISTICS**

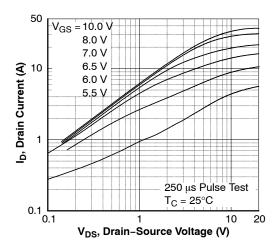
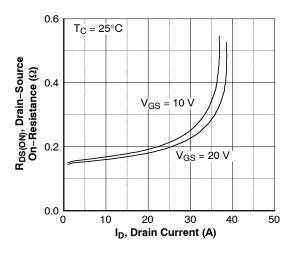
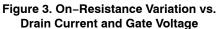


Figure 1. On-Region Characteristics





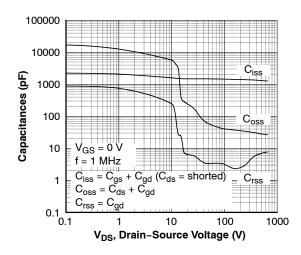


Figure 5. Capacitance Characteristics

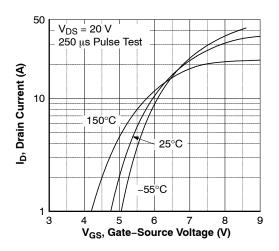
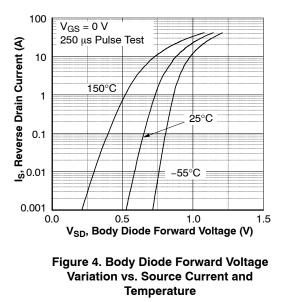


Figure 2. Transfer Characteristics



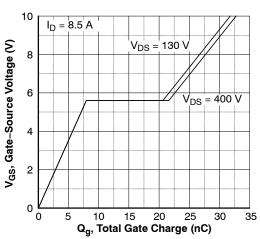
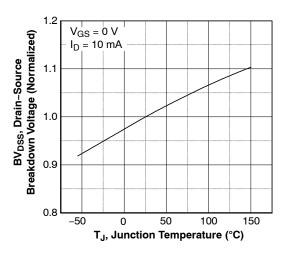


Figure 6. Gate Charge Characteristics

### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





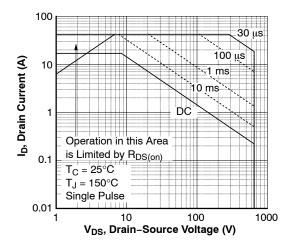


Figure 9. Maximum Safe Operating Area

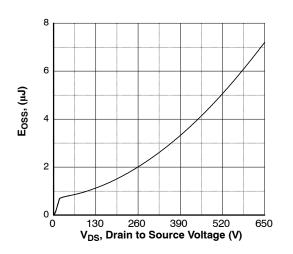


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

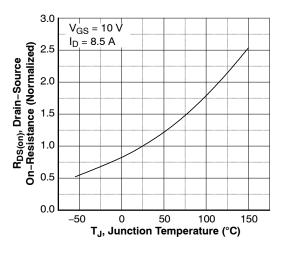


Figure 8. On–Resistance Variation vs. Temperature

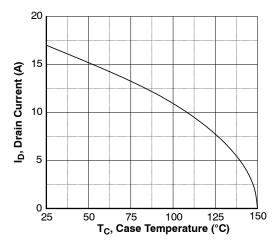


Figure 10. Maximum Drain Current vs. Case Temperature

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

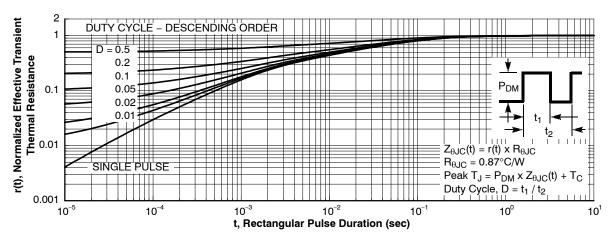
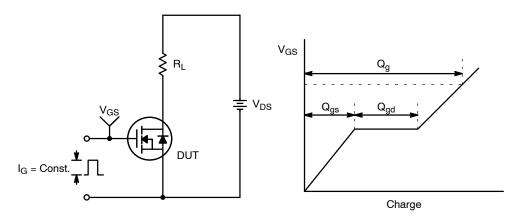


Figure 12. Transient Thermal Response Curve





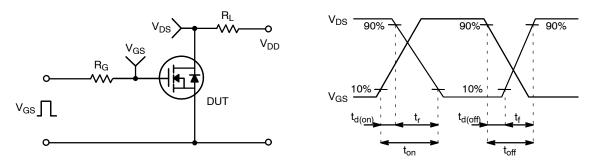
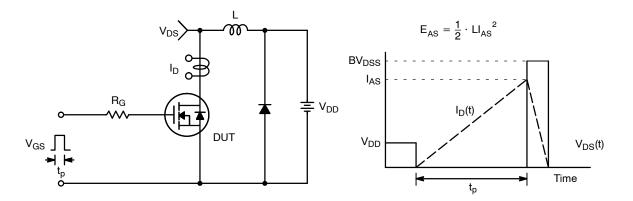


Figure 14. Resistive Switching Test Circuit & Waveforms





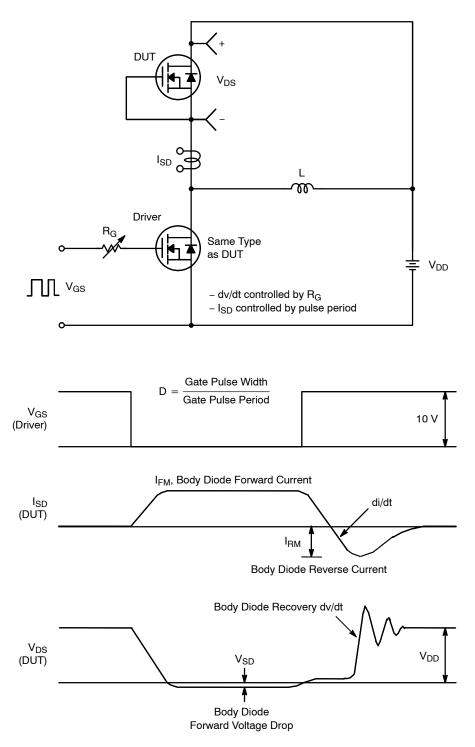


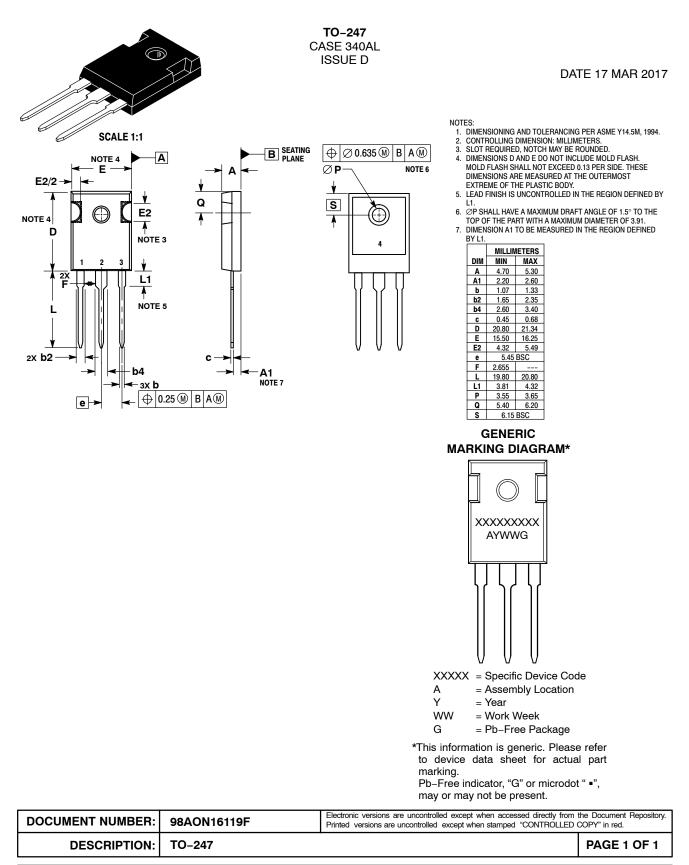
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





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